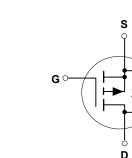
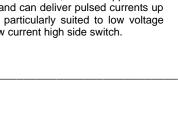
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Symbol	Parameter	BSS84	BSS110	Units
V <sub>DSS</sub>	Drain-Source Voltage	-50		V
$V_{DGR}$	Drain-Gate Voltage ( $R_{GS} \le 20 \text{ K}\Omega$ )	-50		
$V_{GSS}$	Gate-Source Voltage - Continuous	±	V	
I <sub>D</sub>	Drain Current - Continuous @ $T_A = 30/35^{\circ}C$	-0.13	-0.17	A
	- Pulsed @ $T_A = 25^{\circ}C$	-0.52	-0.68	
P <sub>D</sub>	Maximum Power Dissipation $T_A = 25^{\circ}C$	0.36	36 0.63	
T_,,T <sub>stg</sub>	Operating and Storage Temperature Range	-55 to 150		°C
TL	Maximum lead temperature for soldering purposes, 1/16" from case for 10 seconds	3	°C	
THERMA	L CHARACTERISTICS			
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	350	200	°C/W

## D D G TO-92 (97) **BSS110** SOT-23 (TO-236AB) BSS84







#### Features

- BSS84: -0.13A, -50V.  $R_{DS(ON)} = 10\Omega @ V_{GS} = -5V.$ BSS110: -0.17A, -50V.  $R_{DS(ON)} = 10\Omega @ V_{GS} = -10V$
- Voltage controlled p-channel small signal switch.
- High density cell design for low R<sub>DS(ON)</sub>.
- High saturation current.

## **BSS84 / BSS110** P-Channel Enhancement Mode Field Effect Transistor

### **General Description**

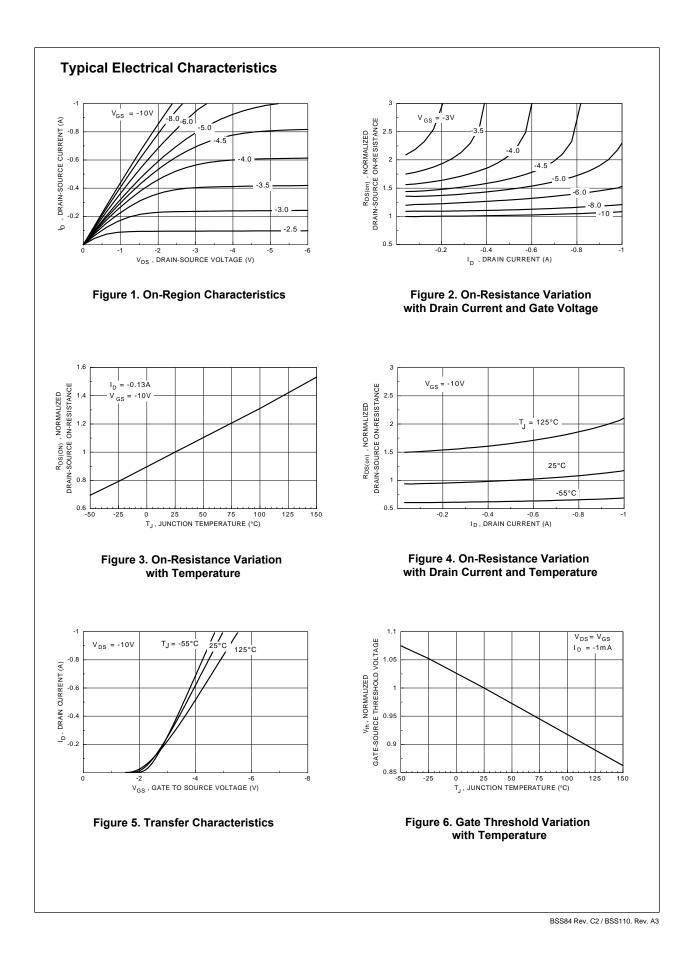
FAIRCHILD

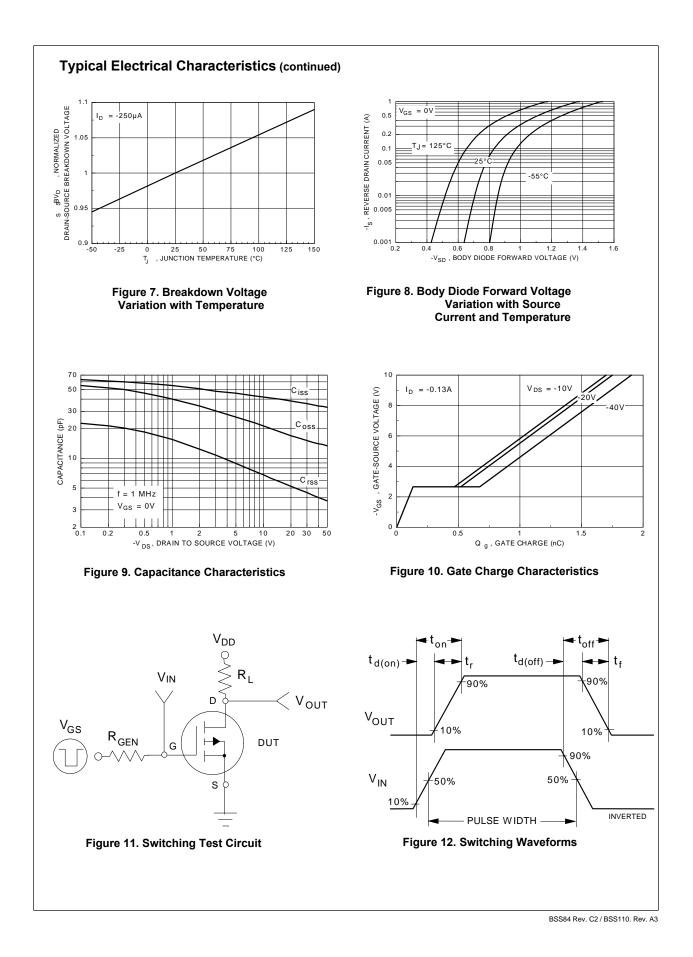
SEMICONDUCTOR TM

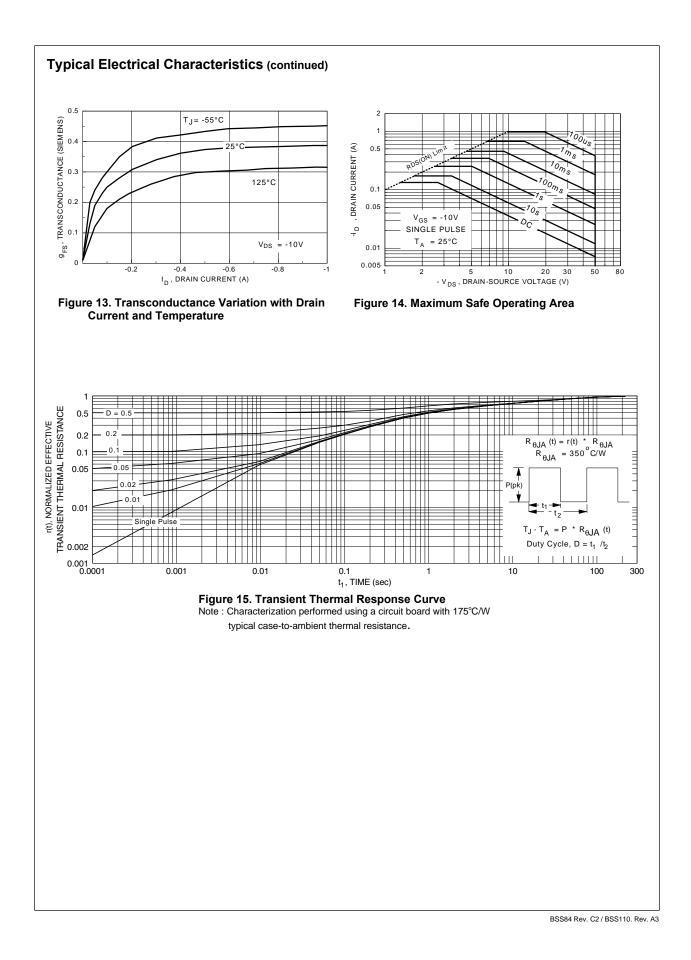
These P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is designed to minimize on-state resistance, provide rugged and reliable performance and fast switching. They can be used, with a minimum of effort, in most applications requiring up to 0.17A DC and can deliver pulsed currents up to 0.68Å. This product is particularly suited to low voltage applications requiring a low current high side switch.

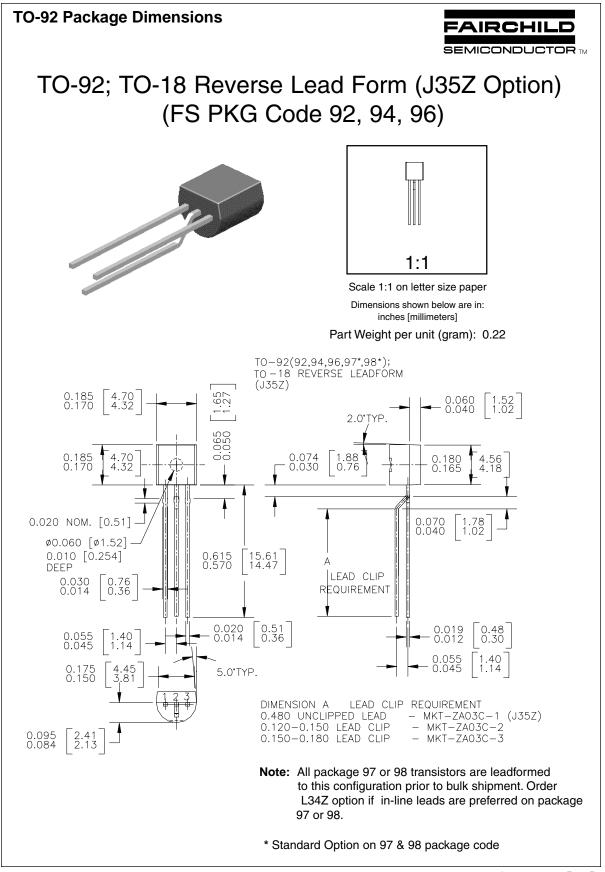
# May 2000

Symbol	Parameter	Conditions		Туре	Min	Тур	Max	Units
OFF CHA	RACTERISTICS	·						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$		All	-50			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -50 V,		All			-15	μA
		$V_{GS} = 0 V$	T <sub>J</sub> = 125°C				-60	μA
		$V_{DS} = -25 V, V_{GS} = 0 V$					-0.1	μA
GSSR	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$		All			-10	nA
ON CHA	RACTERISTICS (Note 1)	·						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -1 \text{ mA}$		All	-0.8	-1.75	-2	V
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -5V, I_{D} = -0.10 \text{ A}$		BSS84		3.2	10	Ω
		$V_{GS} = -10 \text{ V}, I_{D} = -0.17 \text{ A}$		BSS110		2.2	10	1
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = -25 V, I <sub>D</sub> = -0.10A		BSS84	0.05	0.27		S
		$V_{\rm DS} = -10 \text{ V}, \text{ I}_{\rm D} = -0.17 \text{ A}$		BSS110	0.05	0.29		
DYNAMI	C CHARACTERISTICS	·						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -25 V, V_{GS} = 0 V,$ f = 1.0 MHz		BSS84		37	45	pF
				BSS110		37	40	
C <sub>oss</sub>	Output Capacitance			All		16	25	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	-		All		5	12	pF
SWITCHI	NG CHARACTERISTICS (Note 1)	·						
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{\text{DD}} = -30 \text{ V}, \text{ I}_{\text{D}} = -0.27 \text{ A},$ $V_{\text{GS}} = -10 \text{ V}, \text{ R}_{\text{GEN}} = 50 \Omega$		All			12	nS
t,	Turn - On Rise Time			All			50	nS
t <sub>D(off)</sub>	Turn - Off Delay Time			All			10	nS
t.	Turn - Off Fall Time			All			25	nS
T DRAIN-SO	URCE DIODE CHARACTERISTICS							
I <sub>s</sub>	Continuous Source Diode Current			BSS84			-0.13	А
				BSS110			-0.17	
I <sub>SM</sub>	Maximum Pulsed Source Diode Current (Note 1)		BSS84			-0.52	A	
			BSS110			-0.68		
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = -0.26 A$ (Note 1)		BSS84		-0.95	-1.2	_
		$V_{GS} = 0 \text{ V}, \text{ I}_{S} = -0.34 \text{ A}$ (Note 1)		BSS110		-1	-1.2	









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#### PRODUCT STATUS DEFINITIONS

#### **Definition of Terms**

Datasheet Identification	Product Status	Definition
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